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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

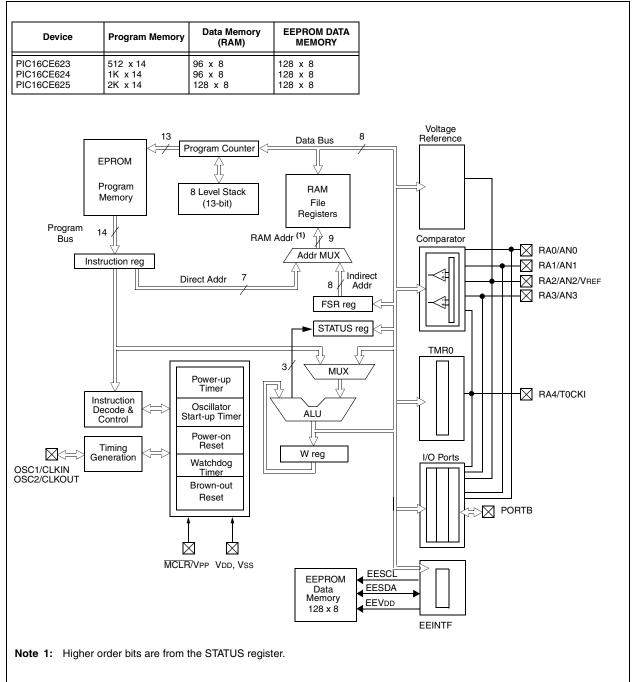
Details

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	13
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	ОТР
EEPROM Size	128 x 8
RAM Size	96 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	18-DIP (0.300", 7.62mm)
Supplier Device Package	18-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16ce624-04i-p

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

FIGURE 3-1: BLOCK DIAGRAM



4.0 MEMORY ORGANIZATION

4.1 <u>Program Memory Organization</u>

The PIC16CE62X has a 13-bit program counter capable of addressing an 8K x 14 program memory space. Only the first 512 x 14 (0000h - 01FFh) for the PIC16CE623, 1K x 14 (0000h - 03FFh) for the PIC16CE624 and 2K x 14 (0000h - 07FFh) for the PIC16CE625 are physically implemented. Accessing a location above these boundaries will cause a wrap-around within the first 512 x 14 space (PIC16CE623) or 1K x 14 space (PIC16CE624) or 2K x 14 space (PIC16CE625). The reset vector is at 0000h and the interrupt vector is at 0004h (Figure 4-1, Figure 4-2, Figure 4-3).

FIGURE 4-1: PROGRAM MEMORY MAP AND STACK FOR THE PIC16CE623

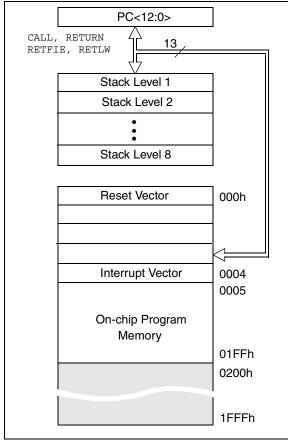


FIGURE 4-2: PROGRAM MEMORY MAP AND STACK FOR THE PIC16CE624

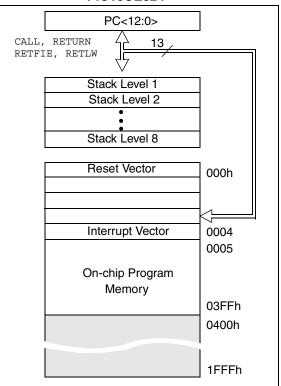
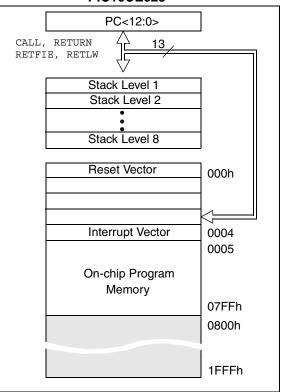


FIGURE 4-3: PROGRAM MEMORY MAP AND STACK FOR THE PIC16CE625



4.2 Data Memory Organization

The data memory (Figure 4-4 and Figure 4-5) is partitioned into two Banks which contain the General Purpose Registers and the Special Function Registers. Bank 0 is selected when the RP0 bit is cleared. Bank 1 is selected when the RP0 bit (STATUS <5>) is set. The Special Function Registers are located in the first 32 locations of each Bank. Register locations 20-7Fh (Bank0) on the PIC16CE623/624 and 20-7Fh (Bank0) and A0-BFh (Bank1) on the PIC16CE625 are General Purpose Registers implemented as static RAM. Some special purpose registers are mapped in Bank 1. In all three microcontrollers, address space F0h-FFh (Bank1) is mapped to 70-7Fh (Bank0) as common RAM.

4.2.1 GENERAL PURPOSE REGISTER FILE

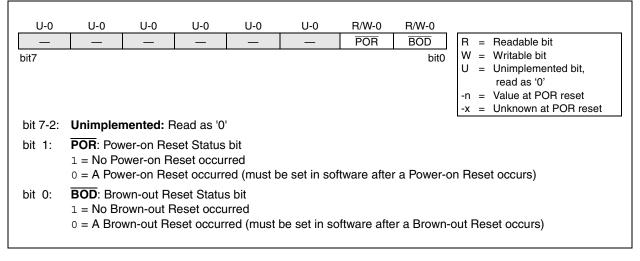
The register file is organized as 96×8 in the PIC16CE623/624 and 128 x 8 in the PIC16CE625. Each is accessed either directly or indirectly through the File Select Register FSR (Section 4.4).

4.2.2.6 PCON REGISTER

The PCON register contains flag bits to differentiate between a Power-on Reset, an external $\overline{\text{MCLR}}$ reset, WDT reset or a Brown-out Reset.

Note:	BOD is unknown on Power-on Reset. It
	must then be set by the user and checked
	on subsequent resets to see if BOD is
	cleared, indicating a brown-out has
	occurred. The BOD status bit is a "don't
	care" and is not necessarily predictable if
	the brown-out circuit is disabled (by
	programming BODEN bit in the
	configuration word).

REGISTER 4-6: PCON REGISTER (ADDRESS 8Eh)



5.2 PORTB and TRISB Registers

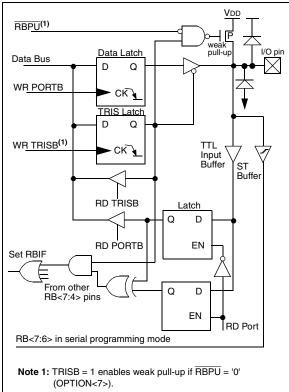
PORTB is an 8-bit wide, bi-directional port. The corresponding data direction register is TRISB. A '1' in the TRISB register puts the corresponding output driver in a high impedance mode. A '0' in the TRISB register puts the contents of the output latch on the selected pin(s).

Reading PORTB register reads the status of the pins, whereas writing to it will write to the port latch. All write operations are read-modify-write operations. So a write to a port implies that the port pins are first read, then this value is modified and written to the port data latch.

Each of the PORTB pins has a weak internal pull-up ($\approx 200 \ \mu A$ typical). A single control bit can turn on all the pull-ups. This is done by clearing the \overline{RBPU} (OPTION<7>) bit. The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on Power-on Reset.

Four of PORTB's pins, RB<7:4>, have an interrupt on change feature. Only pins configured as inputs can cause this interrupt to occur (i.e., any RB<7:4> pin configured as an output is excluded from the interrupt on change comparison). The input pins of RB<7:4> are compared with the old value latched on the last read of PORTB. The "mismatch" outputs of RB<7:4> are OR'ed together to generate the RBIF interrupt (flag latched in INTCON<0>).





This interrupt can wake the device from SLEEP. The user, in the interrupt service routine, can clear the interrupt in the following manner:

- a) Any read or write of PORTB. This will end the mismatch condition.
- b) Clear flag bit RBIF.

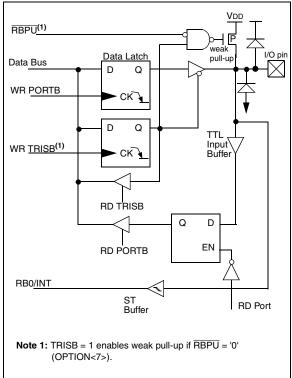
A mismatch condition will continue to set flag bit RBIF. Reading PORTB will end the mismatch condition and allow flag bit RBIF to be cleared.

This interrupt on mismatch feature, together with software configurable pull-ups on these four pins allow easy interface to a key pad and make it possible for wake-up on key-depression. (See AN552, "Implementing Wake-Up on Key Strokes".)

Note:	If a change on the I/O pin should occur					
	when the read operation is being executed					
	(start of the Q2 cycle), then the RBIF inter-					
	rupt flag may not get set.					

The interrupt on change feature is recommended for wake-up on key depression operation and operations where PORTB is only used for the interrupt on change feature. Polling of PORTB is not recommended while using the interrupt on change feature.





7.0 TIMER0 MODULE

The Timer0 module timer/counter has the following features:

- 8-bit timer/counter
- Readable and writable
- 8-bit software programmable prescaler
- Internal or external clock select
- Interrupt on overflow from FFh to 00h
- Edge select for external clock

Figure 7-1 is a simplified block diagram of the Timer0 module.

Timer mode is selected by clearing the TOCS bit (OPTION<5>). In timer mode, the TMR0 will increment every instruction cycle (without prescaler). If Timer0 is written, the increment is inhibited for the following two cycles (Figure 7-2 and Figure 7-3). The user can work around this by writing an adjusted value to TMR0.

Counter mode is selected by setting the T0CS bit. In this mode Timer0 will increment either on every rising or falling edge of pin RA4/T0CKI. The incrementing edge is determined by the source edge (T0SE) control bit (OPTION<4>). Clearing the TOSE bit selects the rising edge. Restrictions on the external clock input are discussed in detail in Section 7.2.

The prescaler is shared between the Timer0 module and the Watchdog Timer. The prescaler assignment is controlled in software by the control bit PSA (OPTION<3>). Clearing the PSA bit will assign the prescaler to Timer0. The prescaler is not readable or writable. When the prescaler is assigned to the Timer0 module, prescale value of 1:2, 1:4, ..., 1:256 are selectable. Section 7.3 details the operation of the prescaler.

7.1 <u>Timer0 Interrupt</u>

Timer0 interrupt is generated when the TMR0 register timer/counter overflows from FFh to 00h. This overflow sets the T0IF bit. The interrupt can be masked by clearing the T0IE bit (INTCON<5>). The T0IF bit (INTCON<2>) must be cleared in software by the Timer0 module interrupt service routine before re-enabling this interrupt. The Timer0 interrupt cannot wake the processor from SLEEP since the timer is shut off during SLEEP. See Figure 7-4 for Timer0 interrupt timing.

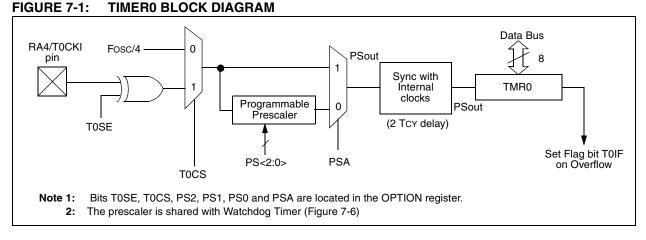
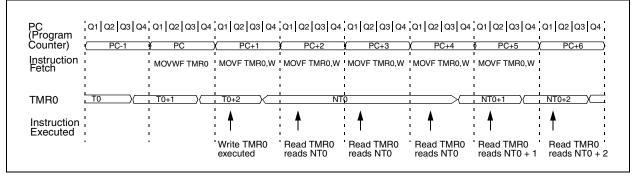


FIGURE 7-2: TIMER0 (TMR0) TIMING: INTERNAL CLOCK/NO PRESCALER



7.3 <u>Prescaler</u>

An 8-bit counter is available as a prescaler for the Timer0 module, or as a postscaler for the Watchdog Timer, respectively (Figure 7-6). For simplicity, this counter is being referred to as "prescaler" throughout this data sheet. Note that there is only one prescaler available which is mutually exclusive between the Timer0 module and the Watchdog Timer. Thus, a prescaler assignment for the Timer0 module means that there is no prescaler for the Watchdog Timer and vice-versa.

The PSA and PS<2:0> bits (OPTION<3:0>) determine the prescaler assignment and prescale ratio.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (i.e., CLRF 1, MOVWF 1, BSF 1, x....etc.) will clear the prescaler. When assigned to WDT, a CLRWDT instruction will clear the prescaler along with the Watchdog Timer. The prescaler is not readable or writable.

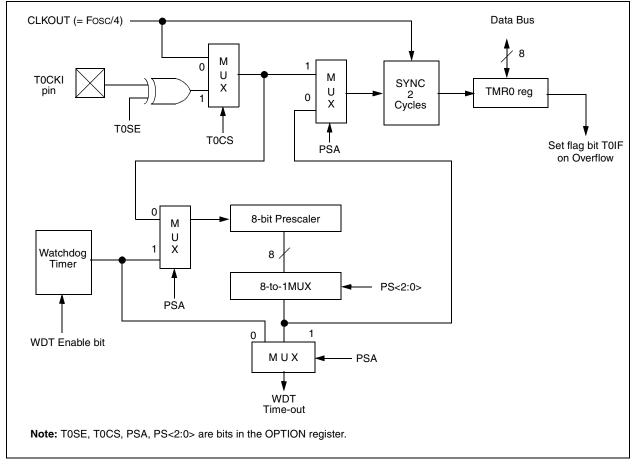


FIGURE 7-6: BLOCK DIAGRAM OF THE TIMER0/WDT PRESCALER

8.6 Comparator Interrupts

The comparator interrupt flag is set whenever there is a change in the output value of either comparator. Software will need to maintain information about the status of the output bits, as read from CMCON<7:6>, to determine the actual change that has occurred. The CMIF bit, PIR1<6>, is the comparator interrupt flag. The CMIF bit must be reset by clearing '0'. Since it is also possible to write a '1' to this register, a simulated interrupt may be initiated.

The CMIE bit (PIE1<6>) and the PEIE bit (INTCON<6>) must be set to enable the interrupt. In addition, the GIE bit must also be set. If any of these bits are clear, the interrupt is not enabled, though the CMIF bit will still be set if an interrupt condition occurs.

Note: If a change in the CMCON register (C1OUT or C2OUT) should occur when a read operation is being executed (start of the Q2 cycle), then the CMIF (PIR1<6>) interrupt flag may not get set.

The user, in the interrupt service routine, can clear the interrupt in the following manner:

- a) Any read or write of CMCON. This will end the mismatch condition.
- b) Clear flag bit CMIF.

A mismatch condition will continue to set flag bit CMIF. Reading CMCON will end the mismatch condition, and allow flag bit CMIF to be cleared.

8.7 <u>Comparator Operation During SLEEP</u>

When a comparator is active and the device is placed in SLEEP mode, the comparator remains active and the interrupt is functional if enabled. This interrupt will wake-up the device from SLEEP mode when enabled. While the comparator is powered-up, higher sleep currents than shown in the power down current specification will occur. Each comparator that is operational will consume additional current as shown in the comparator specifications. To minimize power consumption while in SLEEP mode, turn off the comparators, CM<2:0> = 111, before entering sleep. If the device wakes-up from sleep, the contents of the CMCON register are not affected.

8.8 Effects of a RESET

A device reset forces the CMCON register to its reset state. This forces the comparator module to be in the comparator reset mode, CM<2:0> = 000. This ensures that all potential inputs are analog inputs. Device current is minimized when analog inputs are present at reset time. The comparators will be powered-down during the reset interval.

8.9 <u>Analog Input Connection</u> <u>Considerations</u>

A simplified circuit for an analog input is shown in Figure 8-4. Since the analog pins are connected to a digital output, they have reverse biased diodes to VDD and Vss. The analog input therefore, must be between Vss and VDD. If the input voltage deviates from this range by more than 0.6V in either direction, one of the diodes is forward biased and a latch-up may occur. A maximum source impedance of 10 k Ω is recommended for the analog sources. Any external component connected to an analog input pin, such as a capacitor or a Zener diode, should have very little leakage current.

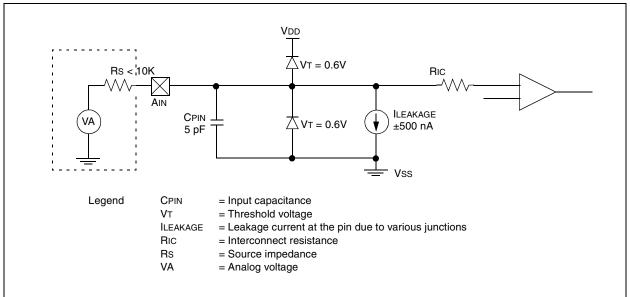


FIGURE 8-4: ANALOG INPUT MODEL

10.4 <u>Power-on Reset (POR), Power-up</u> <u>Timer (PWRT), Oscillator Start-up</u> <u>Timer (OST) and Brown-out Reset</u> (BOD)

10.4.1 POWER-ON RESET (POR)

The on-chip POR circuit holds the chip in reset until VDD has reached a high enough level for proper operation. To take advantage of the POR, just tie the $\overline{\text{MCLR}}$ pin through a resistor to VDD. This will eliminate external RC components usually needed to create Power-on Reset. A maximum rise time for VDD is required. See electrical specifications for details.

The POR circuit does not produce an internal reset when VDD declines.

When the device starts normal operation (exits the reset condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in reset until the operating conditions are met.

For additional information, refer to Application Note AN607, "Power-up Trouble Shooting".

10.4.2 POWER-UP TIMER (PWRT)

The Power-up Timer provides a fixed 72 ms (nominal) time-out on power-up only, from POR or Brown-out Reset. The Power-up Timer operates on an internal RC oscillator. The chip is kept in reset as long as PWRT is active. The PWRT delay allows the VDD to rise to an acceptable level. A configuration bit, PWRTE, can disable (if set) or enable (if cleared or programmed) the Power-up Timer. The Power-up Timer should always be enabled when Brown-out Reset is enabled.

The Power-Up Time delay will vary from chip-to-chip and due to VDD, temperature and process variation. See DC parameters for details.

10.4.3 OSCILLATOR START-UP TIMER (OST)

The Oscillator Start-Up Timer (OST) provides a 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over. This ensures that the crystal oscillator or resonator has started and stabilized.

The OST time-out is invoked only for XT, LP and HS modes and only on power-on reset or wake-up from SLEEP.

10.4.4 BROWN-OUT RESET (BOD)

The PIC16CE62X members have on-chip Brown-out Reset circuitry. A configuration bit, BOREN, can disable (if clear/programmed) or enable (if set) the Brown-out Reset circuitry. If VDD falls below 4.0V (refer to BVDD parameter D005) for greater than parameter (TBOR) in Table 13-5, the brown-out situation will reset the chip. A reset won't occur if VDD falls below 4.0V for less than parameter (TBOR).

On any reset (Power-on, Brown-out, Watch-dog, etc.) the chip will remain in reset until VDD rises above BVDD. The Power-up Timer will then be invoked and will keep the chip in reset an additional 72 ms.

If VDD drops below BVDD while the Power-up Timer is running, the chip will go back into a Brown-out Reset and the Power-up Timer will be re-initialized. Once VDD rises above BVDD, the Power-Up Timer will execute a 72 ms reset. The Power-up Timer should always be enabled when Brown-out Reset is enabled. Figure 10-7 shows typical Brown-out situations.

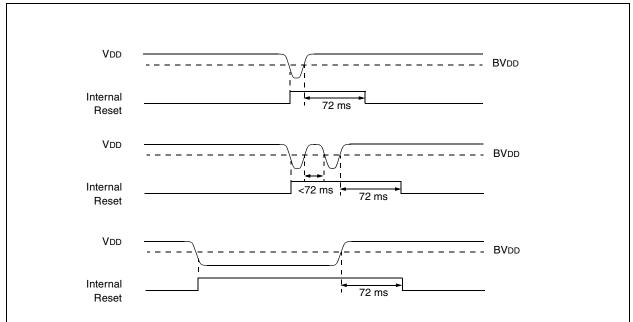


FIGURE 10-7: BROWN-OUT SITUATIONS

10.4.5 TIME-OUT SEQUENCE

On power-up, the time-out sequence is as follows: First PWRT time-out is invoked after POR has expired, then OST is activated. The total time-out will vary based on oscillator configuration and <u>PWRTE</u> bit status. For example, in RC mode with <u>PWRTE</u> bit erased (PWRT disabled), there will be no time-out at all. Figure 10-8, Figure 10-9 and Figure 10-10 depict time-out sequences.

Since the time-outs occur from the POR pulse, if $\overline{\text{MCLR}}$ is kept low long enough, the time-outs will expire. Then bringing $\overline{\text{MCLR}}$ high will begin execution immediately (see Figure 10-9). This is useful for testing purposes or to synchronize more than one $\text{PIC}^{\textcircled{B}}$ device operating in parallel.

Table 10-5 shows the reset conditions for some special registers, while Table 10-6 shows the reset conditions for all the registers.

10.4.6 POWER CONTROL (PCON)/STATUS REGISTER

The power control/status register, PCON (address 8Eh) has two bits.

Bit0 is $\overline{\text{BOR}}$ (Brown-out). $\overline{\text{BOR}}$ is unknown on power-on-reset. It must then be set by the user and checked on subsequent resets to see if $\overline{\text{BOR}} = 0$ indicating that a brown-out has occurred. The $\overline{\text{BOR}}$ status bit is a don't care and is not necessarily predictable if the brown-out circuit is disabled (by setting BODEN bit = 0 in the Configuration word).

Bit1 is POR (Power-on-reset). It is a '0' on power-on-reset and unaffected otherwise. The user must write a '1' to this bit following a power-on-reset. On a subsequent reset, if POR is '0', it will indicate that a power-on-reset must have occurred (VDD may have gone too low).

Oscillator Configuration	Powe	er-up	Brown-out Reset	Wake-up from SLEEP	
Oscillator Configuration	PWRTE = 0	PWRTE = 1	brown-out neset		
XT, HS, LP	72 ms + 1024 Tosc 1024 Tosc		72 ms + 1024 Tosc	1024 Tosc	
RC	72 ms	_	72 ms	—	

TABLE 10-3: TIME-OUT IN VARIOUS SITUATIONS

POR	BOR	TO	PD	
0	Х	1	1	Power-on-reset
0	Х	0	Х	Illegal, TO is set on POR
0	Х	Х	0	Illegal, PD is set on POR

Brown-out Reset

WDT Reset

WDT Wake-up

MCLR reset during normal operation

MCLR reset during SLEEP

TABLE 10-4: STATUS/PCON BITS AND THEIR SIGNIFICANCE

Х

u

0

u

Ο

Legend: x = unknown, u = unchanged

0

1

1

1

1

Х

0

0

u

1

1

1

1

1

1

TABLE 10-5: INITIALIZATION CONDITION FOR SPECIAL REGISTERS

Condition	Program Counter	STATUS Register	PCON Register
Power-on Reset	000h	0001 1xxx	0x
MCLR reset during normal operation	000h	000u uuuu	uu
MCLR reset during SLEEP	000h	0001 0uuu	uu
WDT reset	000h	0000 uuuu	uu
WDT Wake-up	PC + 1	uuu0 0uuu	uu
Brown-out Reset	000h	000x xuuu	u0
Interrupt Wake-up from SLEEP	PC + 1 ⁽¹⁾	uuu1 0uuu	uu

Legend: u = unchanged, x = unknown, - = unimplemented bit, reads as '0'.

Note 1: When the wake-up is due to an interrupt and global enable bit, GIE is set and the PC is loaded with the interrupt vector (0004h) after execution of PC+1.

TABLE 10-6: INITIALIZATION CONDITION FOR REGISTERS

Register	Address	Power-on Reset	 MCLR Reset during normal operation MCLR Reset during SLEEP WDT Reset Brown-out Reset ⁽¹⁾ 	 Wake-up from SLEEP through interrupt Wake-up from SLEEP through WDT time-out
W	-	xxxx xxxx	uuuu uuuu	นนนน นนนน
INDF	00h	-	-	-
TMR0	01h	XXXX XXXX	uuuu uuuu	uuuu uuuu
PCL	02h	0000 0000	0000 0000	PC + 1 ⁽³⁾
STATUS	03h	0001 1xxx	000q quuu ⁽⁴⁾	uuuq quuu ⁽⁴⁾
FSR	04h	xxxx xxxx	uuuu uuuu	นนนน นนนน
PORTA	05h	x xxxx	u uuuu	u uuuu
PORTB	06h	xxxx xxxx	uuuu uuuu	นนนน นนนน
CMCON	1Fh	00 0000	00 0000	uu uuuu
PCLATH	0Ah	0 0000	0 0000	u uuuu
INTCON	0Bh	x000 0000	0000 000u	uuuu uqqq ⁽²⁾
PIR1	0Ch	-0	-0	-q (2,5)
OPTION	81h	1111 1111	1111 1111	นนนน นนนน
TRISA	85h	1 1111	1 1111	u uuuu
TRISB	86h	1111 1111	1111 1111	uuuu uuuu
PIE1	8Ch	-0	-0	-u
PCON	8Eh	0x	uq ^(1,6)	uu
EEINTF	90h	111	111	111
VRCON	9Fh	000- 0000	000- 0000	uuu- uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, reads as '0', q = value depends on condition.

Note 1: If VDD goes too low, Power-on Reset will be activated and registers will be affected differently.

2: One or more bits in INTCON, PIR1 and/or PIR2 will be affected (to cause wake-up).

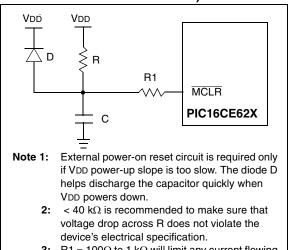
3: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

4: See Table 10-5 for reset value for specific condition.

5: If wake-up was due to comparator input changing , then bit 6 = 1. All other interrupts generating a wake-up will cause bit 6 = u.

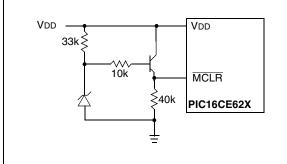
6: If reset was due to brown-out, then PCON bit 0 = 0. All other resets will cause bit 0 = u.

FIGURE 10-11: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)



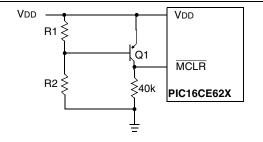
3: $R1 = 100\Omega$ to 1 k Ω will limit any current flowing into MCLR from external capacitor C in the event of MCLR/VPP pin breakdown due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS).

FIGURE 10-12: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 1



- Note 1: This circuit will activate reset when VDD goes below (Vz + 0.7V) where Vz = Zener voltage.
 - 2: Internal Brown-out Reset circuitry should be disabled when using this circuit.

FIGURE 10-13: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 2

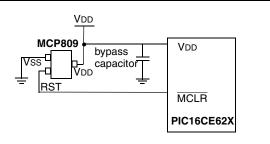


Note 1: This brown-out circuit is less expensive, albeit less accurate. Transistor Q1 turns off when VDD is below a certain level such that:

$$V_{DD} \times \frac{R1}{R1 + R2} = 0.7 V$$

- **2:** Internal brown-out detection should be disabled when using this circuit.
- **3:** Resistors should be adjusted for the characteristics of the transistor.

FIGURE 10-14: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 3



This brown-out protection circuit employs Microchip Technology's MCP809 microcontroller supervisor. The MCP8XX and MCP1XX families of supervisors provide push-pull and open collector outputs with both high and low active reset pins. There are 7 different trip point selections to accommodate 5V and 3V systems.

10.8 Power-Down Mode (SLEEP)

The Power-down mode is entered by executing a SLEEP instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the \overline{PD} bit in the STATUS register is cleared, the \overline{TO} bit is set and the oscillator driver is turned off. The I/O ports maintain the status they had before SLEEP was executed (driving high, low, or hi-impedance).

For lowest current consumption in this mode, all I/O pins should be either at VDD or VSS, with no external circuitry drawing current from the I/O pin, and the comparators and VREF should be disabled. I/O pins that are hi-impedance inputs should be pulled high or low externally to avoid switching currents caused by floating inputs. The TOCKI input should also be at VDD or VSS for lowest current consumption. The contribution from on chip pull-ups on PORTB should be considered.

The MCLR pin must be at a logic high level (VIHMC).

Note:	It should be noted that a RESET generated by a WDT time-out does not drive MCLR						
	by a WDT time-out does not drive MCLR						
	pin low.						

10.8.1 WAKE-UP FROM SLEEP

The device can wake-up from SLEEP through one of the following events:

- 1. External reset input on MCLR pin
- 2. Watchdog Timer Wake-up (if WDT was enabled)
- 3. Interrupt from RB0/INT pin, RB Port change, or the Peripheral Interrupt (Comparator).

The first event will cause a device reset. The two latter events are considered a continuation of program execution. The \overline{TO} and \overline{PD} bits in the STATUS register can be used to determine the cause of device reset. \overline{PD} bit, which is set on power-up is cleared when SLEEP is invoked. \overline{TO} bit is cleared if WDT wake-up occurred.

When the SLEEP instruction is being executed, the next instruction (PC + 1) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is set (enabled), the device executes the instruction after the SLEEP instruction after the SLEEP instruction after the instruction and then branches to the interrupt address (0004h). In cases where the execution of the instruction following SLEEP is not desirable, the user should have an NOP after the SLEEP instruction.

If the global interrupts are disabled (GIE is							
cleared), but any interrupt source has both							
its interrupt enable bit and the correspond-							
ing interrupt flag bits set, the device will							
immediately wake-up from sleep. The							
sleep instruction is completely executed.							

The WDT is cleared when the device wakes-up from sleep, regardless of the source of wake-up.

Q1 Q2 Q3 Q4 Q1 Q	Q2 Q3 Q4 Q1	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4
CLKOUT(4) \		/			
INT pin			· · · · · · · · · · · · · · · · · · ·		i
INTF flag (INTCON<1>)		· · · · ·	Interrupt Latency		
GIE bit (INTCON<7>)	Processor in SLEEP			י ו ו ו	
INSTRUCTION FLOW		· ·	i I I I	1 1	1 1
PC X PC X F	PC+1 X PC+2	X PC+2	PC + 2	(0004h)	0005h
Instruction { Inst(PC) = SLEEP Ins	st(PC + 1)	Inst(PC + 2)	1 I	Inst(0004h)	Inst(0005h)
Instruction executed Inst(PC - 1)	EEP	Inst(PC + 1)	Dummy cycle	Dummy cycle	Inst(0004h)

FIGURE 10-19: WAKE-UP FROM SLEEP THROUGH INTERRUPT

Note 1: XT, HS or LP oscillator mode assumed.

2: TOST = 1024TOSC (drawing not to scale) This delay does not occur for RC osc mode.

3: GIE = '1' assumed. In this case after wake- up, the processor jumps to the interrupt routine. If GIE = '0', execution will continue in-line.

4: CLKOUT is not available in these osc modes, but shown here for timing reference.

10.9 <u>Code Protection</u>

If the code protection bit(s) have not been programmed, the on-chip program memory can be read out for verification purposes.

Note:	Microchip	does	not	recommend	code
	protecting	windov	ved d	evices.	

10.10 ID Locations

Four memory locations (2000h-2003h) are designated as ID locations where the user can store checksum or other code-identification numbers. These locations are not accessible during normal execution but are readable and writable during program/verify. Only the least significant 4 bits of the ID locations are used.

10.11 In-Circuit Serial Programming

The PIC16CE62X microcontrollers can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data, and three other lines for power, ground, and the programming voltage. This allows customers to manufacture boards with unprogrammed devices, and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

The device is placed into a program/verify mode by holding the RB6 and RB7 pins low, while raising the MCLR (VPP) pin from VIL to VIHH (see programming specification). RB6 becomes the programming clock and RB7 becomes the programming data. Both RB6 and RB7 are Schmitt Trigger inputs in this mode.

After reset, to place the device into programming/verify mode, the program counter (PC) is at location 00h. A 6-bit command is then supplied to the device. Depending on the command, 14-bits of program data are then supplied to or from the device, depending if the command was a load or a read. For complete details of serial programming, please refer to the PIC16C6X/7X/9XX Programming Specifications (Literature #DS30228).

A typical in-circuit serial programming connection is shown in Figure 10-20.

FIGURE 10-20: TYPICAL IN-CIRCUIT SERIAL PROGRAMMING CONNECTION

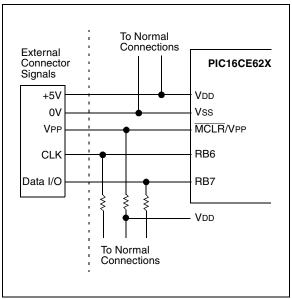


TABLE 11-2: PIC16CE62X INSTRUCTION SET

Mnemonic,		Description	Cycles		14-Bit Opcode				Notes	
Operands				MSb		LSb		Affected		
BYTE-ORIE	NTED	FILE REGISTER OPERATIONS								
ADDWF	f, d	Add W and f	1	00	0111	dfff	ffff	C,DC,Z	1,2	
ANDWF	f, d	AND W with f	1	00	0101	dfff	ffff	Z	1,2	
CLRF	f	Clear f	1	00	0001	lfff	ffff	Z	2	
CLRW	-	Clear W	1	00	0001	0000	0011	Z		
COMF	f, d	Complement f	1	00	1001	dfff	ffff	Z	1,2	
DECF	f, d	Decrement f	1	00	0011	dfff	ffff	Z	1,2	
DECFSZ	f, d	Decrement f, Skip if 0	1(2)	00	1011	dfff	ffff		1,2,	
INCF	f, d	Increment f	1	00	1010	dfff	ffff	Z	1,2	
INCFSZ	f, d	Increment f, Skip if 0	1(2)	00	1111	dfff	ffff		1,2,	
IORWF	f, d	Inclusive OR W with f	1	00	0100	dfff	ffff	Z	1,2	
MOVF	f, d	Move f	1	00	1000	dfff	ffff	Z	1,2	
MOVWF	f	Move W to f	1	00	0000	lfff	ffff			
NOP	-	No Operation	1	00	0000	0xx0	0000			
RLF	f, d	Rotate Left f through Carry	1	00	1101	dfff	ffff	С	1,2	
RRF	f, d	Rotate Right f through Carry	1	00	1100	dfff	ffff	С	1,2	
SUBWF	f, d	Subtract W from f	1	00	0010	dfff	ffff	C,DC,Z	1,2	
SWAPF	f, d	Swap nibbles in f	1	00	1110	dfff	ffff		1,2	
XORWF	f, d	Exclusive OR W with f	1	00	0110	dfff	ffff	Z	1,2	
BIT-ORIENT	FED FIL	E REGISTER OPERATIONS						•		
BCF	f, b	Bit Clear f	1	01	00bb	bfff	ffff		1,2	
BSF	f, b	Bit Set f	1	01	01bb	bfff	ffff		1,2	
BTFSC	f, b	Bit Test f, Skip if Clear	1 (2)	01	10bb	bfff	ffff		3	
BTFSS	f, b	Bit Test f, Skip if Set	1 (2)	01	11bb	bfff	ffff		3	
LITERAL A	ND CO	NTROL OPERATIONS								
ADDLW	k	Add literal and W	1	11	111x	kkkk	kkkk	C,DC,Z		
ANDLW	k	AND literal with W	1	11	1001	kkkk	kkkk	Z		
CALL	k	Call subroutine	2	10	0kkk	kkkk	kkkk			
CLRWDT	-	Clear Watchdog Timer	1	00	0000	0110	0100	TO,PD		
GOTO	k	Go to address	2	10	1kkk	kkkk	kkkk			
IORLW	k	Inclusive OR literal with W	1	11	1000	kkkk	kkkk	Z		
MOVLW	k	Move literal to W	1	11	00xx	kkkk	kkkk			
RETFIE	-	Return from interrupt	2	00	0000	0000	1001			
RETLW	k	Return with literal in W	2	11	01xx	kkkk	kkkk			
RETURN	-	Return from Subroutine	2	00	0000	0000	1000			
	-	Go into standby mode	1	00	0000	0110	0011	TO,PD		
SLEEP				1					1	
SUBLW	k	Subtract W from literal	1	11	110x	kkkk	kkkk	C,DC,Z		

Note 1: When an I/O register is modified as a function of itself (e.g., MOVF PORTB, 1), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned to the Timer0 Module.

3: If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

BCF	Bit Clear f					
Syntax:	[<i>label</i>] B	[<i>label</i>]BCF f,b				
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$					
Operation:	$0 \rightarrow (f < b;$	>)				
Status Affected:	None					
Encoding:	01	00bb	bfff	ffff		
Description:	Bit 'b' in register 'f' is cleared.					
Words:	1					
Cycles:	1					
Example	BCF	FLAG_	REG, 7			
	After Inst	FLAG_RE	EG = 0xC7 EG = 0x47			

BTFSC	Bit Test, Skip if Clear				
Syntax:	[label] BTFSC f,b				
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$				
Operation:	skip if $(f < b >) = 0$				
Status Affected:	None				
Encoding:	01 10bb bfff ffff				
Description:	If bit 'b' in register 'f' is '0', then the next instruction is skipped. If bit 'b' is '0', then the next instruction fetched during the current instruction execution is discarded, and a NOP is executed instead, making this a two-cycle instruction.				
Words:	1				
Cycles:	1(2)				
Example	HERE BTFSC FLAG,1 FALSE GOTO PROCESS_CODE TRUE • •				
	Before Instruction PC = address HERE				
	PC = address HERE After Instruction if FLAG<1> = 0, PC = address TRUE if FLAG<1>=1, PC = address FALSE				

BSF	Bit Set f				
Syntax:	[<i>label</i>] BSF f,b				
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ 0 \leq b \leq 7 \end{array}$				
Operation:	$1 \rightarrow (f < b;$	>)			
Status Affected:	None				
Encoding:	01 01bb bfff ffff				
Description:	Bit 'b' in register 'f' is set.				
Words:	1				
Cycles:	1				
Example	BSF	FLAG_F	REG, 7		
	After Inst	FLAG_RE	EG = 0x0A EG = 0x8A		

SWAPF	Swap Nibbles in f	XORLW	Exclusive OR Literal with W			
Syntax:	[label] SWAPF f,d	Syntax:	[<i>label</i>] XORLW k			
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in [0,1] \end{array}$	Operands:	0 ≤ k ≤ 255			
Operation:	$(f<3:0>) \rightarrow (dest<7:4>),$ $(f<7:4>) \rightarrow (dest<3:0>)$	Operation: Status Affected:	(W) .XOR. $k \rightarrow (W)$			
Status Affected:	None	Encoding:	11 1010 kkkk kkkk			
Encoding:	00 1110 dfff ffff	Description:	The contents of the W register are			
Description:	The upper and lower nibbles of register 'f' are exchanged. If 'd' is 0, the result is placed in W register. If 'd' is 1, the result is placed in register 'f'.	Words:	XOR'ed with the eight bit literal 'k'. The result is placed in the W register. 1			
Words:	1	Cycles:	1			
Cycles:	1	Example:	XORLW 0xAF			
Example	SWAPF REG, 0		Before Instruction			
·	Before Instruction		W = 0xB5			
	REG1 = 0xA5		After Instruction			
	After Instruction		W = 0x1A			
	$\begin{array}{rcl} REG1 &=& 0xA5\\ W &=& 0x5A \end{array}$					

TRIS	Load TRIS Register			
Syntax:	[label]	TRIS	f	
Operands:	$5 \leq f \leq 7$			
Operation:	$(W) \rightarrow TF$	RIS regis	ster f;	
Status Affected:	None			
Encoding:	0 0	0000	0110	Offf
Description: Words: Cycles:	The instru- compatibil products. readable a directly ad 1	ity with th Since TR and writab	e PIC16C IS register le, the use	5X rs are
Example				
		-	rd compa	-
	with futu not use t		ACU production.	ucts, do

XORWF	Exclusive OR W with f					
Syntax:	[label]	XORWF	f,d			
Operands:	$\begin{array}{l} 0 \leq f \leq 127 \\ d \in [0,1] \end{array}$					
Operation:	(W) .XOF	$R.(f) \to (o)$	dest)			
Status Affected:	Z					
Encoding:	0 0	0110	dfff	f fff		
Description:		with regis s stored ir	ster 'f'. n the V			
Words:	1					
Cycles:	1					
Example	XORWF	REG	1			
	Before Instruction					
		REG W	= =	0xAF 0xB5		
	After Inst	ruction				
		REG W	= =	0x1A 0xB5		

NOTES:

13.2 DC CHARACTERISTICS: F

PIC16LCE62X-04 (Commercial, Industrial)

DC CHARACTERISTICS			$\begin{array}{llllllllllllllllllllllllllllllllllll$				
Param No.	Sym	Characteristic	Min	Тур†	Мах	Units	Conditions
D001	Vdd	Supply Voltage	2.5	-	5.5	V	See Figure 13-1 through Figure 13-3
D002	Vdr	RAM Data Retention Voltage (Note 1)	-	1.5*	-	V	Device in SLEEP mode
D003	VPOR	VDD start voltage to ensure Power-on Reset	-	Vss	-	V	See section on power-on reset for details
D004	SVDD	VDD rise rate to ensure Power-on Reset	.05*	-	-	V/ms	See section on power-on reset for details
D005	VBOR	Brown-out Detect Voltage	3.7	4.0	4.35	V	BOREN configuration bit is cleared
D010	IDD	Supply Current (Note 2)	-	1.2	2.0	mA	Fosc = 4 MHz, VDD = 5.5V, WDT disabled, XT osc mode, (Note 4)*
			-	-	1.1	mA	FOSC = 4 MHz, VDD = 2.5V, WDT disabled,
			-	35	70	μA	XT osc mode, (Note 4) Fosc = 32 kHz, VDD = 2.5V, WDT disabled, LP osc mode
D020	IPD	Power Down Current (Note 3)	_	-	2.0	μA	VDD = 2.5V
			-	-	2.2	μA	VDD = 3.0V*
			-	-	9.0	μA	VDD = 5.5V
			-	-	15	μA	VDD = 5.5V Extended
D022	Δ IWDT	WDT Current (Note 5)	-	6.0	10	μA	VDD=4.0V
D022A	Δ IBOR	Brown-out Reset Current	_	75	12 125	μ Α μΑ	$(125^{\circ}C)$ BOD enabled, VDD = 5.0V
D023		(Note 5) Comparator Current for each Comparator (Note 5)	-	30	60	μA	VDD = 4.0V
D023A	Δ IVREF	VREF Current (Note 5)	-	80	135	μA	VDD = 4.0V
	Δ IEE Write	Operating Current	-		3	mA	Vcc = 5.5V, SCL = 400 kHz
	$\Delta IEE \ Read$	Operating Current	-		1	mA	
	ΔIEE	Standby Current	-		30	μA	VCC = 3.0V, EE VDD = VCC
	ΔIEE	Standby Current	-		100	μA	VCC = 3.0V, EE VDD = VCC
1A	Fosc	LP Oscillator Operating Frequency	0	—	200	kHz	All temperatures
		RC Oscillator Operating Frequency		—	4	MHz	All temperatures
		XT Oscillator Operating Frequency	0	—	4 20	MHz	All temperatures
		HS Oscillator Operating Frequency	-		20	MHz	All temperatures

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C, unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tri-stated, pulled to VDD,

MCLR = VDD; WDT enabled/disabled as specified.

3: The power down current in SLEEP mode does not depend on the oscillator type. Power down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD or Vss.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula Ir = VDD/2Rext (mA) with Rext in kΩ.

5: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

6: Commercial temperature range only.

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